

SKKD 152/16 H1



SEMIPACK® 2

Rectifier Diode Modules

SKKD 152/16 H1

Features

- Heat transfer through aluminium oxide ceramic insulated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E63532
- Silver free

Typical Applications*

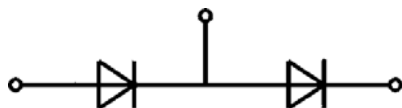
- Non-controllable rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors

Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
Rectifier Diode				
I _{FAV}	sin. 180°	T _c = 85 °C	171	A
		T _c = 100 °C	132	A
I _{FRMS}	continuous operation		270	A
I _{FSM}	10 ms	T _j = 25 °C	5000	A
		T _j = 135 °C	4500	A
i ² t	10 ms	T _j = 25 °C	125000	A ² s
		T _j = 135 °C	101250	A ² s
V _{RSM}			1700	V
V _{RRM}			1600	V
T _j			-40 ... 135	°C
Module				
T _{stg}			-40 ... 125	°C
V _{isol}	a.c.; 50 Hz; r.m.s.	1 min	3000	V
		1 s	3600	V

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
Diode						
V _F	T _J = 25 °C, I _F = 450 A				1.56	V
V _(TO)	T _J = 135 °C				0.82	V
r _T	T _J = 135 °C				1.35	mΩ
I _{RD}	T _J = 135 °C, V _{RD} = V _{RRM}				3	mA
R _{th(j-c)}	cont.	per chip			0.2	K/W
		per module			0.1	K/W
R _{th(j-c)}	sin. 180°	per chip			0.21	K/W
		per module			0.105	K/W
Module						
R _{th(c-s)}	chip			0.1		K/W
	module			0.05		K/W
M _s	to heatsink M5		4.25		5.75	Nm
M _t	to terminals M6		4.25		5.75	Nm
a					5 * 9,81	m/s ²
w				165		g



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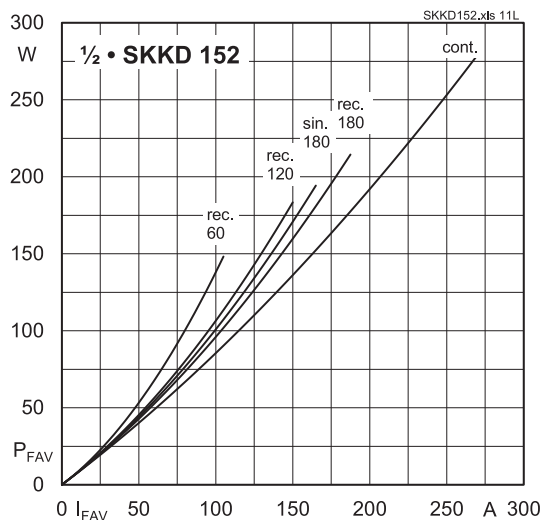


Fig. 11L: Power dissipation per diode vs. forward current

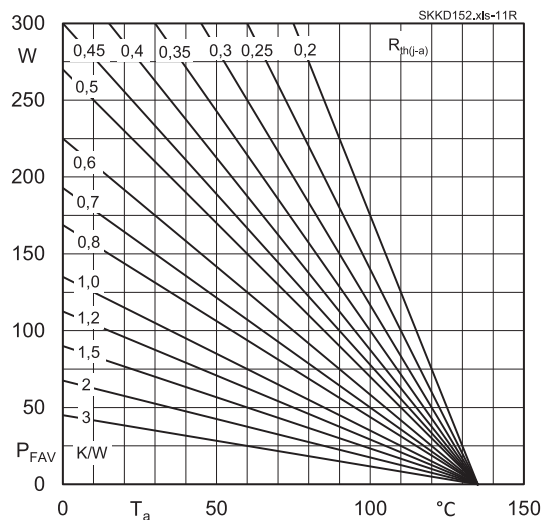


Fig. 11R: Power dissipation per diode vs. ambient temperature

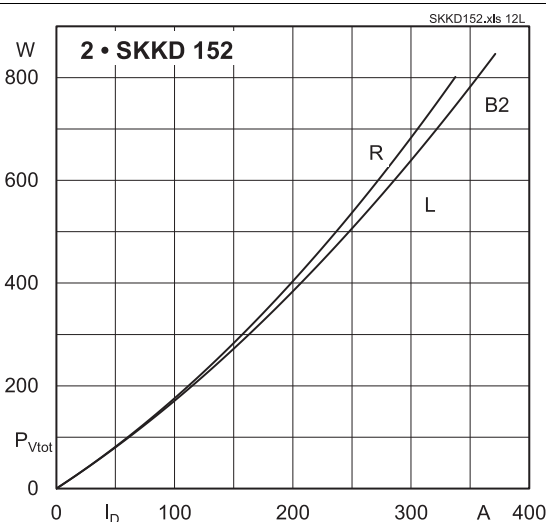


Fig. 12L: Power dissipation of two modules vs. direct current

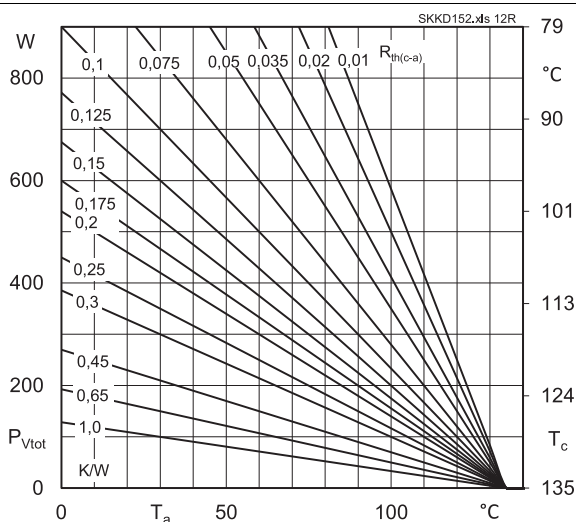


Fig. 12R: Power dissipation of two modules vs. case temperature

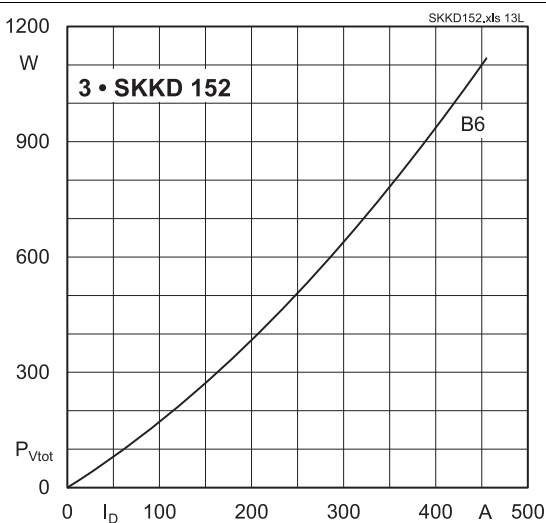


Fig. 13L: Power dissipation of three modules vs. direct current

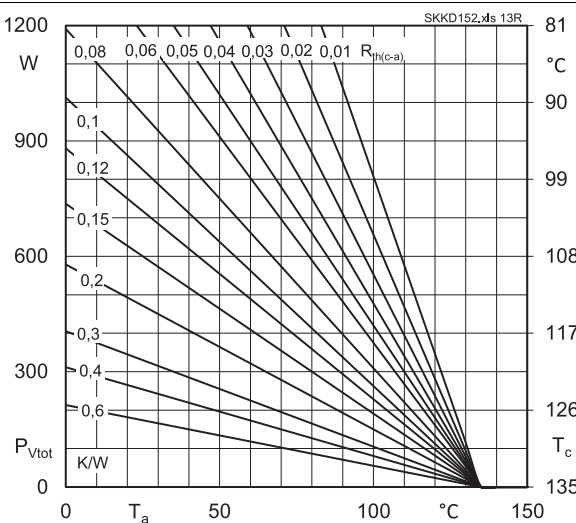


Fig. 13R: Power dissipation of three modules vs. case temperature

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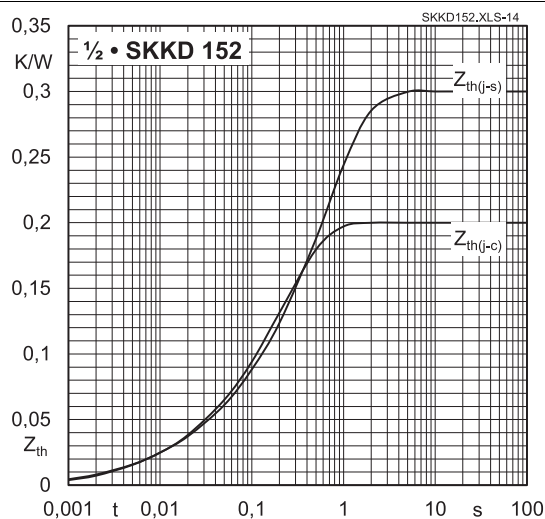


Fig. 14: Transient thermal impedance vs. time

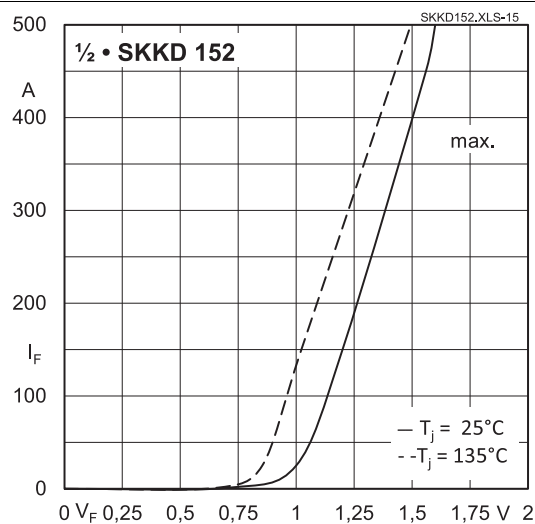


Fig. 15: Forward characteristics

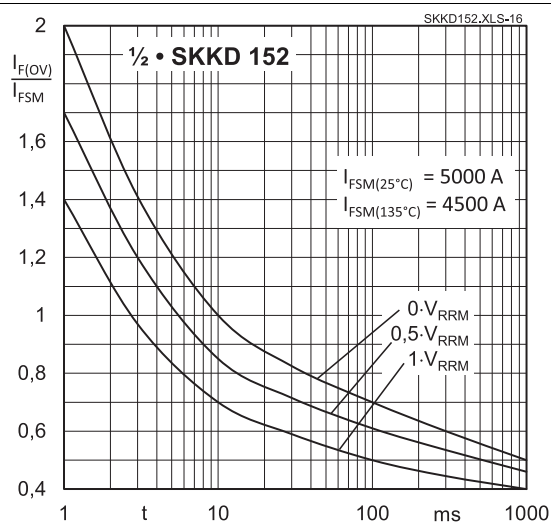
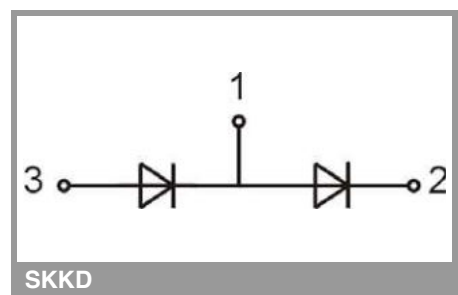
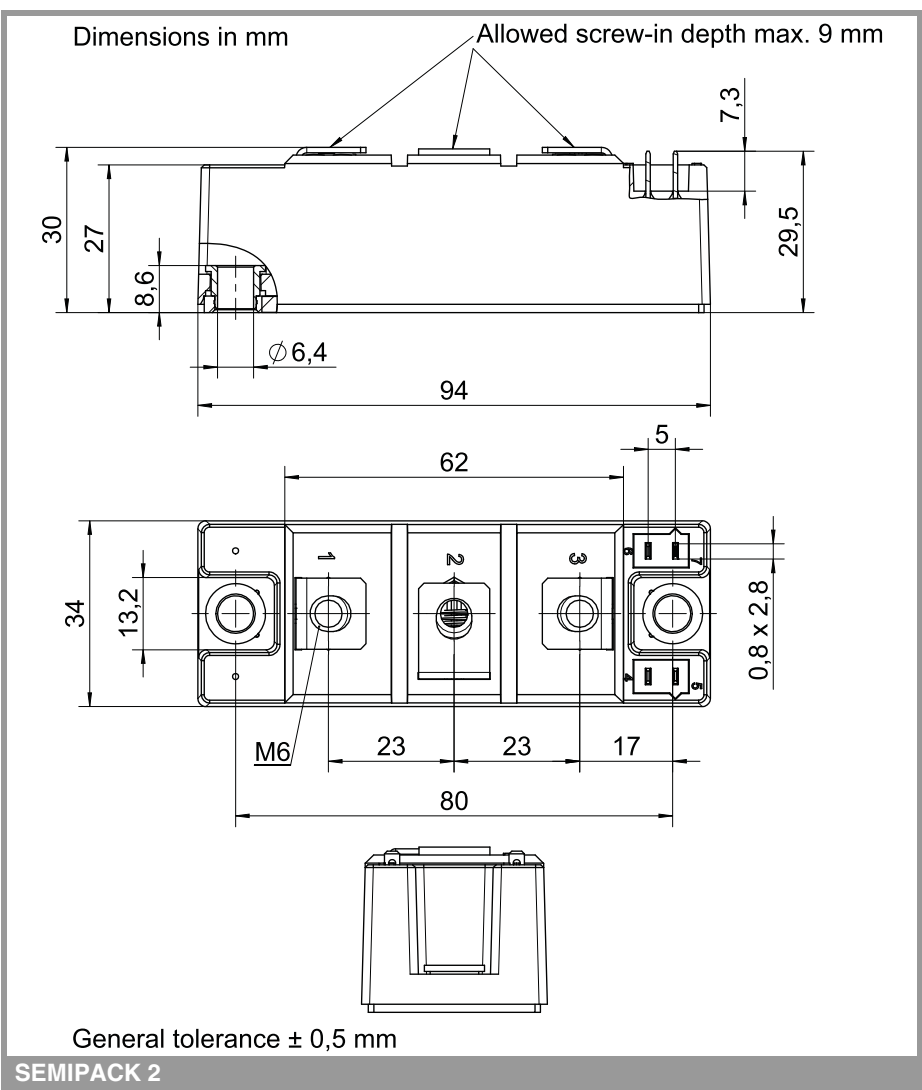


Fig. 16: Surge overload current vs. time

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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.